

# MOS FIELD EFFECT TRANSISTOR **2SK3454**

# SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

# DESCRIPTION

The 2SK3454 is N-channel MOS FET device that features a low on-state resistance and excellent switching characteristics, and designed for high voltage applications such as DC/DC converter.

# ORDERING INFORMATION

PART NUMBER	PACKAGE			
2SK3454	Isolated TO-220			

## FEATURES

•Gate voltage rating  $\pm 30 \text{ V}$ •Low on-state resistance RDS(on) = 0.63  $\Omega$  MAX. (VGs = 10 V, ID = 4.0 A) •Low input capacitance Ciss = 400 pF TYP. (VDs = 10 V, VGs = 0 V) •Built-in gate protection diode •Isolated TO-220 package

# ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (VGs = 0 V)	VDSS	250	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±30	V
Drain Current(DC) (Tc = 25°C)	D(DC)	±7.0	А
Drain Current(pulse) Note1	D(pulse)	±21	А
Total Power Dissipation (T <sub>A</sub> = 25°C)	P <sub>T1</sub>	2.0	W
Total Power Dissipation (Tc = 25°C)	P <sub>T2</sub>	30	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C
Single Avalanche Current Note2	las	7.0	А
Single Avalanche Energy Note2	Eas	49	mJ

**Notes1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

**2.** Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = 125 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V $\rightarrow$ 0 V

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The mark **★** shows major revised points.

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# ELECTRICAL CHARACTERISTICS (TA = 25°C)

Characteristics	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Drain Leakage Current	IDSS	V <sub>DS</sub> = 250 V, V <sub>GS</sub> = 0 V			100	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Gate to Source Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.5		4.5	V
Forward Transfer Admittance	y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 4.0 A	1.0			S
Drain to Source On-state Resistance	RDS(on)	Vgs = 10 V, Id = 4.0 A		0.5	0.63	Ω
Input Capacitance	Ciss	Vps = 10 V		400		pF
Output Capacitance	Coss	Vgs = 0 V		110		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		55		pF
Turn-on Delay Time	Td(on)	Vdd = 125 V, Id = 4.0 A		11		ns
Rise Time	Tr	VGS(on) = 10 V		18		ns
Turn-off Delay Time	Td(off)	R <sub>G</sub> = 10 Ω		32		ns
Fall Time	Tf			15		ns
Total Gate Charge	QG	V <sub>DD</sub> = 200 V		18		nC
Gate to Source Charge	Q <sub>GS</sub>	Vgs = 10 V		3.5		nC
Gate to Drain Charge	Qgd	ID = 7.0 A		10		nC
Diode Forward Voltage	VF(S-D)	IF = 7.0 A, VGS = 0 V		1.0		V
Reverse Recovery Time	Тrr	IF = 7.0 A, VGS = 0 V		250		ns
Reverse Recovery Charge	Qrr	di/dt = 50 A/µs		1.0		μC

# TEST CIRCUIT 1 AVALANCHE CAPABILITY

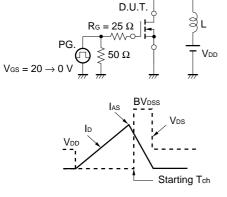
## **TEST CIRCUIT 2 SWITCHING TIME**

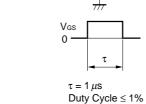
7/7

D.U.T. ¢

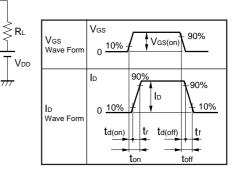
VVV.

Rg

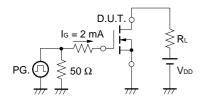




PG

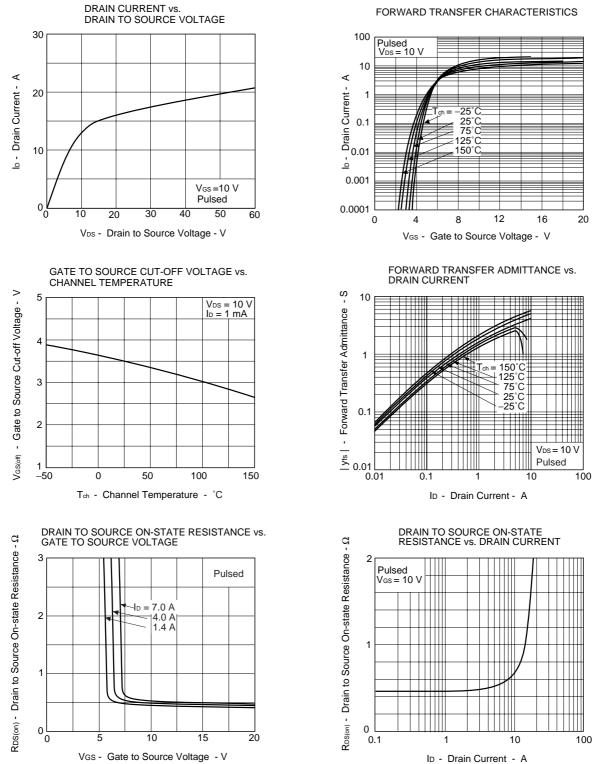


#### **TEST CIRCUIT 3 GATE CHARGE**



Data Sheet D14756EJ1V0DS00

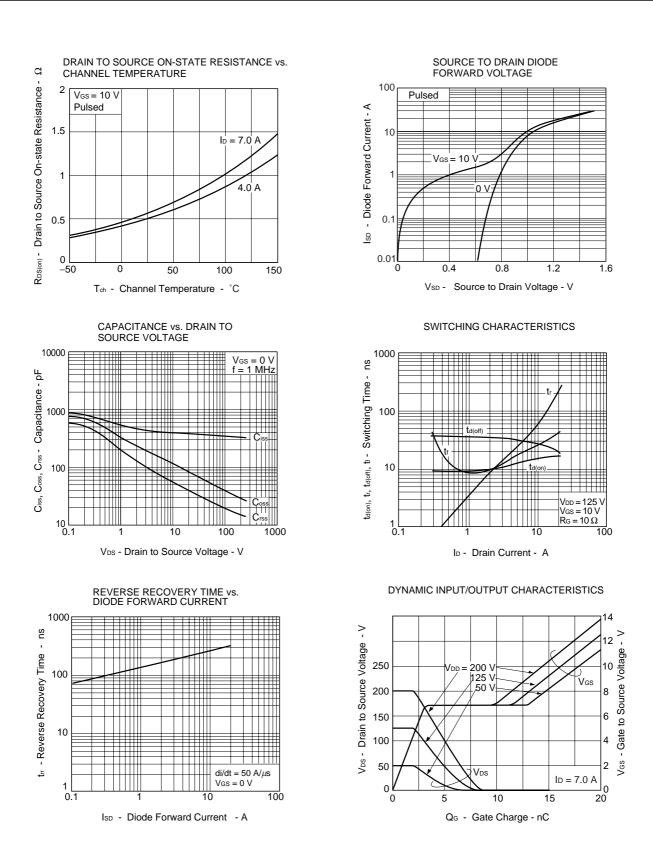
### **TYPICAL CHARACTERISTICS**



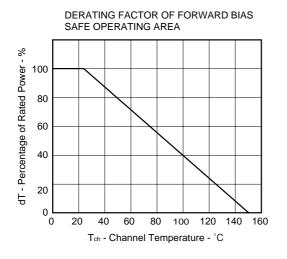
Data Sheet D14756EJ1V0DS00

#### FORWARD TRANSFER CHARACTERISTICS

NEC

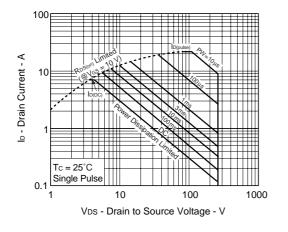


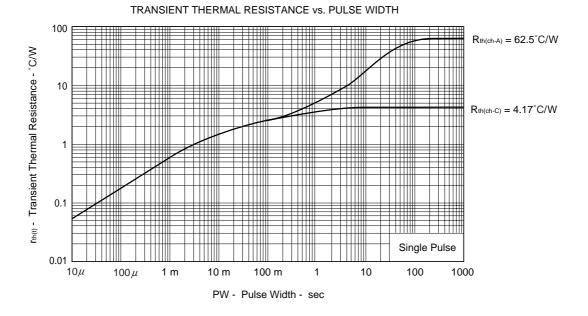
Data Sheet D14756EJ1V0DS00



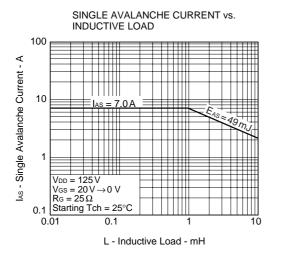
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE PT - Total Power Dissipation - W 0 Tc - Case Temperature - °C

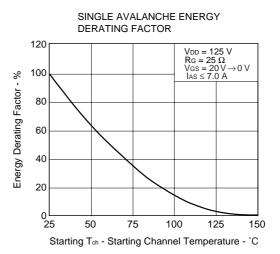
FORWARD BIAS SAFE OPERATING AREA





Data Sheet D14756EJ1V0DS00

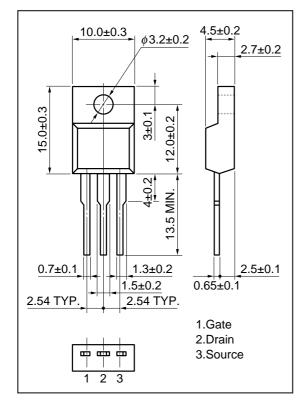




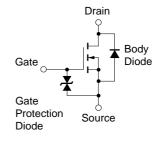
Data Sheet D14756EJ1V0DS00

# PACKAGE DRAWING(Unit : mm)

# Isolated TO-220 (MP-45F)



**EQUIVALENT CIRCUIT** 



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device. • The information in this document is current as of October, 2000. The information is subject to change without notice. For actual design-in, refer to the latest publications of NEC's data sheets or data books, etc., for the most up-to-date specifications of NEC semiconductor products. Not all products and/or types are available in every country. Please check with an NEC sales representative for availability and additional information.

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